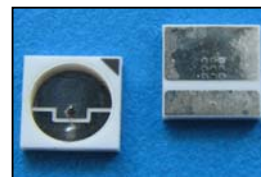




## LED20FC-SMD5



### TECHNICAL DATA

#### Mid-Infrared LED, Flip-Chip Design, SMD

Light Emitting Diodes with central wavelength 2.02  $\mu\text{m}$  series are based on heterostructures grown on GaSb substrates. Solid solutions GaInAsSb are used in active layer. Wide band gap solid solutions AlGaAsSb with Al content 64% are used for good electron confinement. LED20FC-SMD5 has a stable output power and a lifetime more than 80000 hours.

#### Features

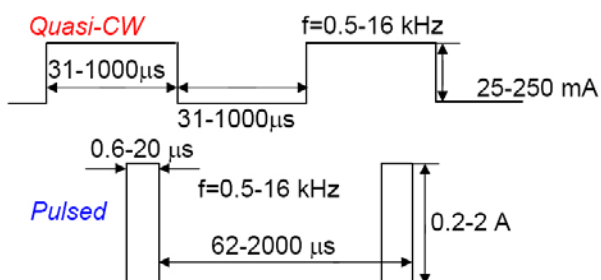
- Structure: GaInAsSb/AlGaAsSb
- Peak Wavelength: typ. 2.02  $\mu\text{m}$
- Optical Output Power: typ. 1.2 mW qCW
- Package: SMD 5x5 mm



#### Specifications

| Item                   | Condition                                                           | Rating |      |      | Unit               |
|------------------------|---------------------------------------------------------------------|--------|------|------|--------------------|
|                        |                                                                     | Min.   | Typ. | Max. |                    |
| Peak Wavelength        | T=300 K                                                             | 2.00   | 2.02 | 2.09 | $\mu\text{m}$      |
| FWHM                   | 150 mA CW                                                           | 100    | 150  | 250  | nm                 |
| Quasi-CW Optical Power | 200 mA qCW                                                          | 0.8    | 1.2  | 1.8  | mW                 |
| Pulsed Optical Power   | 1 A                                                                 | 20     | 30   | 40   | mW                 |
| Switching Time         | T=300 K                                                             | 10     | 20   | 30   | ns                 |
| Operation Voltage      | 200 mA qCW                                                          |        |      |      | V                  |
| Operating Temperature  | -240 ... +50                                                        |        |      |      | $^{\circ}\text{C}$ |
| Emitting Area          | 670x770                                                             |        |      |      | $\mu\text{m}$      |
| Soldering Temperature  | 180                                                                 |        |      |      | $^{\circ}\text{C}$ |
| Package                | SMD type package 5x5 mm based on high thermal conductivity ceramics |        |      |      |                    |

#### Operating Regime



#### Quasi-CW

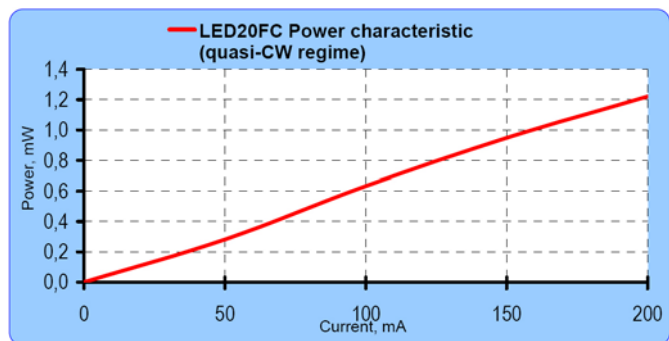
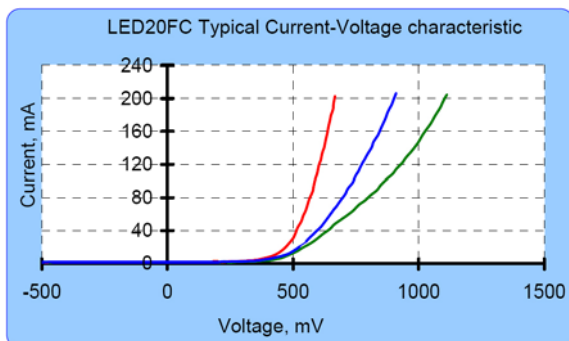
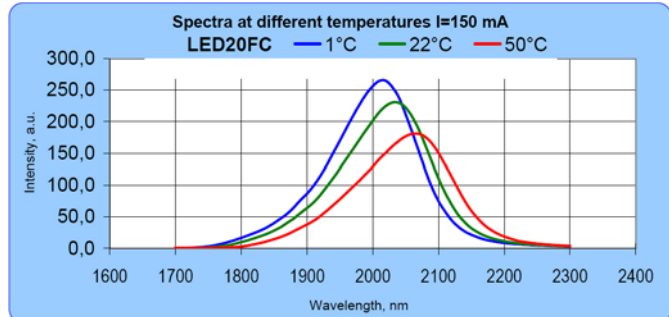
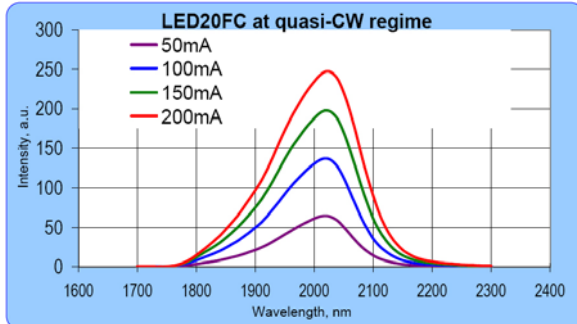
- Maximum current 220 mA
- Recommended current 150-200mA

#### Pulsed

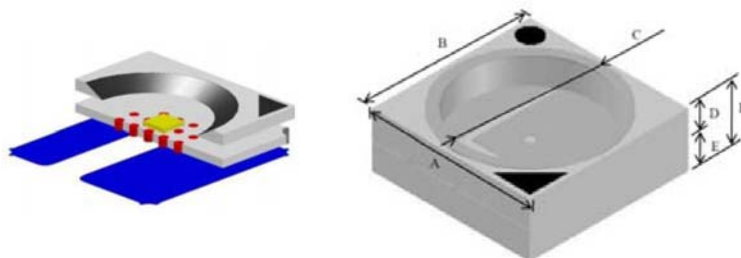
- Maximum current 1 A (puls length 500 ns, repetition rate 2kHz)



## Typical Performance Curves



## Package



| ITEM          | Symbol | Rule        |
|---------------|--------|-------------|
| Basic Outline | A      | 5.0 ± 0.1mm |
| Basic Outline | B      | 5.0 ± 0.1mm |
| Cavity size   | C      | Max 4.2Φ    |
| Top layer     | D      | Min 0.4mm   |
| Bottom layer  | E      | Min 0.4mm   |
| Thickness     | F      | Max 2mm     |

- Tiny package for surface mounting
- Anode and cathode are led to the metalized areas on the back side of the ceramic surface
- Material – Low Temperature Co-fired Ceramic (LTCC):
  - thermal conductivity 25 W/mK
  - thermoresistance 8 °C/W